MBRD320, MBRD340 and MBRD360 are Preferred Devices

SWITCHMODE[™] Power Rectifiers

DPAK Surface Mount Package

Designed for use as output rectifiers, free wheeling, protection and steering diodes in switching power supplies, inverters and other inductive switching circuits. These state–of–the–art devices have the following features:

Features

- Pb–Free Packages are Available
- Extremely Fast Switching
- Extremely Low Forward Drop
- Platinum Barrier with Avalanche Guardrings

Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 0.4 Gram (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes; 260°C Max. for 10 Seconds
- Shipped 75 Units Per Plastic Tube
- Available in 16 mm Tape and Reel, 2500 Units Per Reel, by Adding a "T4" Suffix to the Part Number





MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 3 of this data sheet.

Preferred devices are recommended choices for future use and best overall value.

MAXIMUM RATINGS

Rating	Symbol	MBRD					
		320	330	340	350	360	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		20	30	40	50	60	V
Average Rectified Forward Current ($T_C = +125^{\circ}C$, Rated V_R)	I _{F(AV)}	3			А		
Peak Repetitive Forward Current, T _C = +125°C (Rated V _R , Square Wave, 20 kHz)	I _{FRM}	6			A		
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I _{FSM}	75		A			
Peak Repetitive Reverse Surge Current (2 μs, 1 kHz)	I _{RRM}	1		А			
Operating Junction Temperature Range	TJ	-65 to +150		°C			
Storage Temperature Range	T _{stg}	-65 to +175		°C			
Voltage Rate of Change (Rated V _R)	dv/dt	10,000		V/µs			

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

Maximum Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	6	°C/W
Maximum Thermal Resistance, Junction-to-Ambient (Note 1)		80	°C/W

ELECTRICAL CHARACTERISTICS

	VF	0.6 0.45 0.7 0.625	V
Maximum Instantaneous Reverse Current (Note 2) (Rated dc Voltage, $T_C = +25^{\circ}C$) (Rated dc Voltage, $T_C = +125^{\circ}C$)	İR	0.2 20	mA

1. Rating applies when surface mounted on the minimum pad size recommended.

2. Pulse Test: Pulse Width = 300 μ s, Duty Cycle \leq 2.0%.

ORDERING INFORMATION

Device	Package	Shipping [†]		
MBRD320	DPAK	75 Units / Rail		
MBRD320RL	DPAK	1800 Tape & Reel		
MBRD320RLG	DPAK (Pb–Free)	1800 Tape & Reel		
MBRD320T4	DPAK	2500 Tape & Reel		
MBRD320T4G	DPAK (Pb–Free)	2500 Tape & Reel		
MBRD330	DPAK	75 Units / Rail		
MBRD330RL	DPAK	1800 Tape & Reel		
MBRD330T4	DPAK	2500 Tape & Reel		
MBRD340	DPAK	75 Units / Rail		
MBRD340G	DPAK (Pb–Free)	75 Units / Rail		
MBRD340RL	DPAK	1800 Tape & Reel		
MBRD340T4	DPAK	2500 Tape & Reel		
MBRD340T4G	DPAK (Pb–Free)	2500 Tape & Reel		
MBRD350	DPAK	75 Units / Rail		
MBRD350RL	DPAK	1800 Tape & Reel		
MBRD350T4	DPAK	2500 Tape & Reel		
MBRD360	DPAK	75 Units / Rail		
MBRD360G	DPAK (Pb–Free)	75 Units / Rail		
MBRD360RL	DPAK	1800 Tape & Reel		
MBRD360RLG	DPAK (Pb–Free)	1800 Tape & Reel		
MBRD360T4	DPAK	2500 Tape & Reel		
MBRD360T4G	DPAK (Pb–Free)	2500 Tape & Reel		

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.



TYPICAL CHARACTERISTICS

Figure 1. Typical Forward Voltage





Figure 5. Current Derating, Ambient



Figure 6. Typical Capacitance

PACKAGE DIMENSIONS

DPAK CASE 369C ISSUE O



NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.

	INC	HES	MILLIM	IETERS	
DIM	MIN	MAX	MIN	MAX	
A	0.235	0.245	5.97	6.22	
В	0.250	0.265	6.35	6.73	
С	0.086	0.094	2.19	2.38	
D	0.027	0.035	0.69	0.88	
Е	0.018	0.023	0.46	0.58	
F	0.037	0.045	0.94	1.14	
G	0.180 BSC		4.58 BSC		
н	0.034	0.040	0.87	1.01	
J	0.018	0.023	0.46	0.58	
ĸ	0.102	0.114	2.60	2.89	
L	0.090 BSC		2.29 BSC		
R	0.180	0.215	4.57	5.45	
S	0.025	0.040	0.63	1.01	
U	0.020		0.51		
V	0.035	0.050	0.89	1.27	
Z	0.155		3.93		

SOLDERING FOOTPRINT*



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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PUBLICATION ORDERING INFORMATION

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